

First Announcement

The 9th Structural Engineers World Congress (SEWC 2025)

(17-18 April, 2025, Shanghai, China)

Organized by

Tongji University

Tongji Architectural Design (Group) Co., Ltd.

SEWC China Group



Co-organized by

Journal of Building Structure

Conference Date

17-18 April, 2025

Conference Venue

Auditorium, 1F, Tongji Architectural Design (Group) Co., Ltd., 1230 Siping Road, Shanghai, China

Introduction

The Structural Engineers World Congress (SEWC) is dedicated to the Art, Science and Practice of Structural Engineering. The SEWC aims to cover major aspects pertaining to contemporary technical and professional issues affecting the structural engineering profession worldwide and to highlight the profession's impact and its interface with the societies. It gives an excellent platform for structural engineering professionals to interact with each other and to learn more about what is happening in the world of structural engineering now and the trends in the future. The first SEWC was held in San Francisco in 1998, which was the first international congress covering all aspects of structural engineering, both technical and professional practice issues. The 9th SEWC is now proposed to promote international collaborations and to facilitate exchange and discussion of the up-to-date information on the techniques of each country. In addition, the 9th SEWC offers an ideal opportunity to visit Shanghai, a modern-day city perched at the mouth of the Yangtze River with its collection of skyscrapers, bridges, museums and art galleries, and of course good food and entertainment.

The congress is intended to gather researchers and practitioners world-wide with the background in engineering disciplines related to structure who will share the latest results of research and successful case studies. The theme of the congress is structural engineering for a resilient city.

Scopes and Topics (include, but are not limited to)

- Building and bridge design and construction
- Special structures

- New materials
- New Theories
- ITC and AI technology
- Retrofitting of existing structures
- Structural health monitoring
- Codes, regulations, guidelines for the design of structures
- Disaster prevention and mitigation
- Global warming/climate change prevention

Preliminary Program

Date	Morning	Afternoon	Evening
April 16 (WED)	—	Registration	Registration
April 17 (THU)	Invited keynote presentation	Invited keynote presentation	Banquet
April 18 (FRI)	Invited keynote presentation	Technical tour	—

Scientific Committee

Chair: Xilin Lu (China)

Co-chair: Akira Wada (Japan)

Members:

Gorun Arun (Türkiye)	James R. Cagley (USA)	Sung Pil Chang(South Korea)
Jiemin Ding (China)	Maria E. Moreyra Garlock (USA)	Ing Mauro Eugenio Giuliani (Italy)
Yasuhiro Hayabe (Japan)	Gorman Ho (China)	Lim Peng Hong (Singapore)
Ken'ichi Kawaguchi (Japan)	Seung Deog Kim (China)	Young Min Kim (South Korea)
Abhishek Murthy (Singapore)	Qingying Ren (China)	Satwant S Rihal (USA)
Juan Gerardo Oliva Salinas (Mexico)	Ing. Enzo Siviero (Italy)	Knut Stockhusen(Germany)
R. Sundaram (India)	Romuald Tarczewski (Poland)	

Organizing Committee

Chair: Jieming Ding (China)

Co-Chair: Qilin Zhang (China) Huanjun Jiang (China)

Members(China):

Bin Wang	Ying Zhou	Honglei Wu	Qiao Zhao	Shiyu Wang
Dingyan Wu	Jiaojiao Shi	Xuhong Qiang	Ye Liu	Xin Li

Registrations

Registration Category	Early Bird Registration (Before Jan. 31, 2025)	Standard Registration (Feb. 1-Apr. 15, 2025)	On-site Registration (Apr. 16-17, 2025)
Delegate	RMB 2,200 (USD 310)	RMB 2,500 (USD 350)	RMB 2,800 (USD 390)
Student	RMB 1,200 (USD 160)	RMB 1,300 (USD 180)	RMB 1,500 (USD 200)
Accompanying Person	RMB 1,200 (USD 160)	RMB 1,300 (USD 180)	RMB 1,500 (USD 200)

Note: The conference website is under construction. It will be provided soon. Please submit your registration information in the website when it is ready.

Website: <http://www.sewc2025.com/>

Contact information

Journal of Building Structure

Add: Rm.411, Building 13, Yutaoyuan District 3, Xizhimennei Street, Xicheng District, Beijing 100035, P.R. China

Tel: +86-10-57369042/57369049

Tongji University

Add: 1239, Siping Road, Shanghai, P.R. China

Tel: +86-21-65986151/65980531

Email: sewc2025@163.com